

## **GENERAL DESCRIPTION**

The 83054 is a low skew, 4:1, Single-ended Multiplexer and a member of the family of High Performance Clock Solutions from IDT. The 83054 has four selectable single-ended clock inputs and one single-ended clock output. The output has a  $V_{_{DDO}}$  pin which may be set at 3.3V, 2.5V, or 1.8V, making the device ideal for use in voltage translation applications. An output enable pin places the output in a high impedance state which may be useful for testing or debug purposes. The device operates up to 250MHz and is packaged in a 16 TSSOP package.

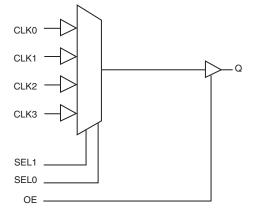
## **F**EATURES

- 4:1 single-ended multiplexer
- Q nominal output impedance:  $7\Omega$  (V<sub>ppo</sub> = 3.3V)
- Maximum output frequency: 250MHz
- Propagation delay: 3ns (maximum),  $V_{DD} = V_{DDD} = 3.3V$
- Input skew: 225ps (maximum),  $V_{DD} = V_{DDO} = 3.3V$
- Part-to-part skew: 780ps (maximum),  $V_{DD} = V_{DDD} = 3.3V$
- Additive phase jitter, RMS: 0.19ps (typical), 3.3V/3.3V
- Operating supply modes:

V<sub>D</sub>/V 3.3V/3.3V 3.3V/2.5V 3.3V/1.8V 2.5V/2.5V 2.5V/1.8V

- -40°C to 85°C ambient operating temperature
- Available in lead-free (RoHS 6) package

## **BLOCK DIAGRAM**



## **PIN ASSIGNMENT**

Q C nc C OE C CLK3 C GND C nc C SEL1 C CLK2 C	2 1 3 1 4 1	6 VDDO 5 nc 4 CLK0 3 nc 2 VDD 1 nc 0 CLK1 9 SEL0
CLK2	8	9 SEL0

### 83054 16-Lead TSSOP 4.4mm x 5.0mm x 0.92mm package body G Package Top View

### TABLE 1. PIN DESCRIPTIONS

Number	Name	Туре		Description
1	Q	Output		Single-ended clock output. LVCMOS/LVTTL interface levels.
3	OE	Input	Pullup	Output enable. When LOW, outputs are in HIGH impedance state. When HIGH, outputs are active. LVCMOS / LVTTL interface levels.
4, 8, 10, 14	CLK3, CLK2, CLK1, CLK0	Input	Pulldown	Single-ended clock inputs. LVCMOS/LVTTL interface levels.
5	GND	Power		Power supply ground.
7, 9	SEL1, SEL0	Input	Pulldown	Clock select input. See Control Input Function Table. LVCMOS / LVTTL interface levels.
2, 6, 11, 13, 15	nc	Unused		No connect.
12	V	Power		Power and input supply pin.
16	V	Power		Output supply pin.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

### TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C	Input Capacitance			4		pF
R	Input Pullup Resistor			51		kΩ
	Input Pulldown Resistor			51		kΩ
	Power Dissipation Capacitance (per output)	V = 3.465V		18		pF
C		V = 2.625V		20		pF
		V = 1.89V		30		pF
		V = 3.465V		7		Ω
R <sub>out</sub>	Output Impedance	V = 2.625V		7		Ω
		V = 1.89V		10		Ω

### TABLE 3. CONTROL INPUT FUNCTION TABLE

Contro	l Inputs	Input Selected to Q
SEL1	SEL0	
0	0	CLK0
0	1	CLK1
1	0	CLK2
1	1	CLK3

# RENESAS

### ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V	4.6V
Inputs, V	-0.5V to V <sub>DD</sub> + 0.5 V
Outputs, V <sub>o</sub>	-0.5V to $V_{_{DDO}}$ + 0.5V
Package Thermal Impedance, $\boldsymbol{\theta}_{_{\!$	89°C/W (0 lfpm)
Storage Temperature, $T_{_{\mathrm{STG}}}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

### TABLE 4A. Power Supply DC Characteristics, $V_{DD} = V_{DDD} = 3.3V \pm 5\%$ , TA = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		3.135	3.3	3.465	V
	Power Supply Current				40	mA
	Output Supply Current				5	mA

Table 4B. Power Supply DC Characteristics,  $V_{_{DD}}$  = 3.3V±5%,  $V_{_{DDO}}$  = 2.5V±5%, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		2.375	2.5	2.625	V
	Power Supply Current				40	mA
	Output Supply Current				5	mA

### Table 4C. Power Supply DC Characteristics, $V_{dd} = 3.3V \pm 5\%$ , $V_{ddo} = 1.8V \pm 0.2V$ , Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		1.71	1.8	1.89	V
	Power Supply Current				40	mA
	Output Supply Current				5	mA

### TABLE 4D. Power Supply DC Characteristics, $V_{DD} = V_{DDD} = 2.5V \pm 5\%$ , TA = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		2.375	2.5	2.625	V
V	Output Supply Voltage		2.375	2.5	2.625	V
I DD	Power Supply Current				35	mA
I DDO	Output Supply Current				5	mA

### Table 4E. Power Supply DC Characteristics, $V_{dd} = 2.5V \pm 5\%$ , $V_{dd} = 1.8V \pm 0.2V$ , Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		2.375	2.5	2.625	V
V	Output Supply Voltage		1.71	1.8	1.89	V
I	Power Supply Current				35	mA
l ddo	Output Supply Current				5	mA

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V			$V_{_{DD}} = 3.3V \pm 5\%$	2		V <sub>DD</sub> + 0.3	V
V <sub>IH</sub>	Input High Voltage		$V_{_{DD}} = 2.5V \pm 5\%$	1.7		V <sub>DD</sub> + 0.3	V
V	Input Low Voltage		$V_{_{DD}} = 3.3V \pm 5\%$	-0.3		0.8	V
V <sub>IL</sub>	Input Low Voltage		$V_{_{DD}} = 2.5V \pm 5\%$	-0.3		0.7	V
I III	Input High Current	CLK0:CLK3, SEL0, SEL1	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$			150	μA
IH		OE	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$			5	μA
1	Input Low Current	CLK0:CLK3, SEL0, SEL1	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$	-5			μA
IL.		OE	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$	-150			μA
		-	$V_{_{DDO}} = 3.3V \pm 5\%; \text{ NOTE 1}$	2.6			V
V <sub>oh</sub>	Output HighVoltage		$V_{_{DDO}} = 2.5V \pm 5\%; \text{ NOTE 1}$	1.8			V
			$V_{_{DDO}} = 1.8V \pm 5\%; \text{ NOTE } 1$	V <sub>DD</sub> - 0.3			V
			$V_{_{DDO}} = 3.3V \pm 5\%; \text{ NOTE 1}$			0.5	V
V <sub>ol</sub>	Output Low Voltage	•	$V_{_{DDO}} = 2.5V \pm 5\%; \text{ NOTE 1}$			0.45	V
			V <sub>DD0</sub> = 1.8V ± 5%; NOTE 1			0.35	V

### TABLE 4F. LVCMOS/LVTTL DC CHARACTERISTICS, TA = -40°C TO 85°C

NOTE 1: Outputs terminated with 50 $\Omega$  to V<sub>DDD</sub>/2. See Parameter Measurement section, "Load Test Circuit" diagrams.

TABLE 5A. AC CHARACTERISTICS, $V_{D}$	$= V_{DDC}$	$= 3.3V \pm 5\%$	Та = -40°С то 85°С
---------------------------------------	-------------	------------------	--------------------

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency				250	MHz
tp	Propagation Delay, Low to High; NOTE 1		2.4	2.7	3.0	ns
tp <sub>н∟</sub>	Propagation Delay, High to Low; NOTE 1		2.5	2.7	2.9	ns
<i>t</i> sk(i)	Input Skew; NOTE 2			55	225	ps
<i>t</i> jit	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter Section; NOTE 3	155.52MHz, (12kHz to 20MHz)		0.19		ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 4				780	ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	50		500	ps
odc	Output Duty Cycle		45		55	%
	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Driving only one input clock.

NOTE 4: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{_{DDO}}/2$ .

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency				250	MHz
tp	Propagation Delay, Low to High; NOTE 1		2.5	2.8	3.1	ns
tp <sub>⊣∟</sub>	Propagation Delay, High to Low; NOTE 1		2.6	2.8	3.0	ns
<i>t</i> sk(i)	Input Skew; NOTE 2			45	150	ps
<i>t</i> jit	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter Section; NOTE 3	155.52MHz, (12kHz to 20MHz)		0.14		ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 4				780	ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	50		500	ps
odc	Output Duty Cycle		45		55	%
	MUX Isolation	@ 100MHz		45		dB

Table 5B. AC Characteristics,  $V_{_{DD}} = 3.3V \pm 5\%$ ,  $V_{_{DDO}} = 2.5V \pm 5\%$ , Ta = -40°C to 85°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Driving only one input clock.

NOTE 4: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{pop}/2$ .

### **TABLE 5C. AC CHARACTERISTICS,** $V_{_{DD}} = 3.3V \pm 5\%$ , $V_{_{DDO}} = 1.8V \pm 5\%$ , TA = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency				250	MHz
tp	Propagation Delay, Low to High; NOTE 1		2.7	3.2	3.8	ns
tp <sub>HL</sub>	Propagation Delay, High to Low; NOTE 1		2.8	3.3	3.8	ns
<i>t</i> sk(i)	Input Skew; NOTE 2			50	150	ps
<i>t</i> jit	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter Section; NOTE 3	155.52MHz, (12kHz to 20MHz)		0.16		ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 4				780	ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	100		700	ps
odc	Output Duty Cycle		45		55	%
	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Driving only one input clock.

NOTE 4: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{pro}/2$ .

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency				250	MHz
tp	Propagation Delay, Low to High; NOTE 1		2.5	3.0	3.5	ns
tp <sub>н∟</sub>	Propagation Delay, High to Low; NOTE 1		2.5	2.9	3.4	ns
<i>t</i> sk(i)	Input Skew; NOTE 2			60	175	ps
tjit	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter Section; NOTE 3	155.52MHz, (12kHz to 20MHz)		0.21		ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 4				780	ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	100		500	ps
odc	Output Duty Cycle		40		60	%
	MUX Isolation	@ 100MHz		45		dB

Table 5D. AC Characteristics,  $V_{_{DD}} = V_{_{DDO}} = 2.5V \pm 5\%$ , Ta = -40°C to 85°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Driving only one input clock.

NOTE 4: Defined as skew between outputs on different devices operating a the same supply voltages and

with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{_{DDO}}/2$ .

## Table 5E. AC Characteristics, $V_{_{DD}}$ = 2.5V ± 5%, $V_{_{DDO}}$ = 1.8V ± -5%, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f	Output Frequency				250	MHz
tp	Propagation Delay, Low to High; NOTE 1		2.6	3.3	4.0	ns
tp <sub>нL</sub>	Propagation Delay, High to Low; NOTE 1		2.7	3.3	4.0	ns
<i>t</i> sk(i)	Input Skew; NOTE 2			50	150	ps
tjit	Buffer Additive Phase Jitter, RMS; refer to Additive Phase Jitter Section; NOTE 3	155.52MHz, (12kHz to 20MHz)		0.17		ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 4				780	ps
t <sub>_R</sub> / t <sub>_F</sub>	Output Rise/Fall Time	20% to 80%	100		700	ps
odc	Output Duty Cycle		40		60	%
	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

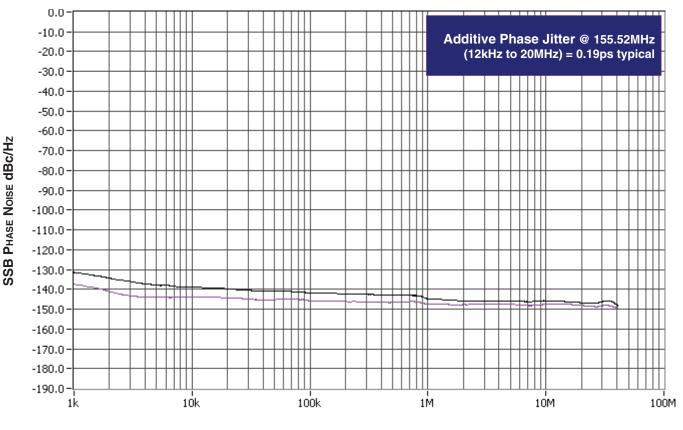
NOTE 3: Driving only one input clock.

NOTE 4: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at V \_\_\_\_/2.

## Additive Phase Jitter

The spectral purity in a band at a specific offset from the fundamental compared to the power of the fundamental is called the *dBc Phase Noise*. This value is normally expressed using a Phase noise plot and is most often the specified plot in many applications. Phase noise is defined as the ratio of the noise power present in a 1Hz band at a specified offset from the fundamental frequency to the power value of the fundamental. This ratio is expressed in decibels (dBm) or a ratio of the power in the 1Hz band to the power in the

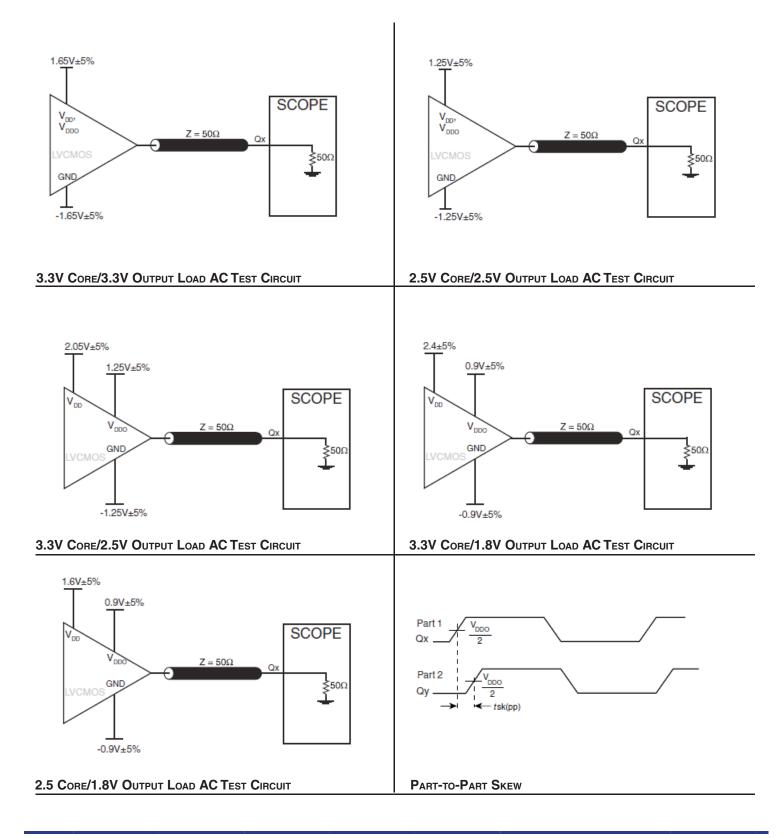
fundamental. When the required offset is specified, the phase noise is called a *dBc* value, which simply means dBm at a specified offset from the fundamental. By investigating jitter in the frequency domain, we get a better understanding of its effects on the desired application over the entire time record of the signal. It is mathematically possible to calculate an expected bit error rate given a phase noise plot.

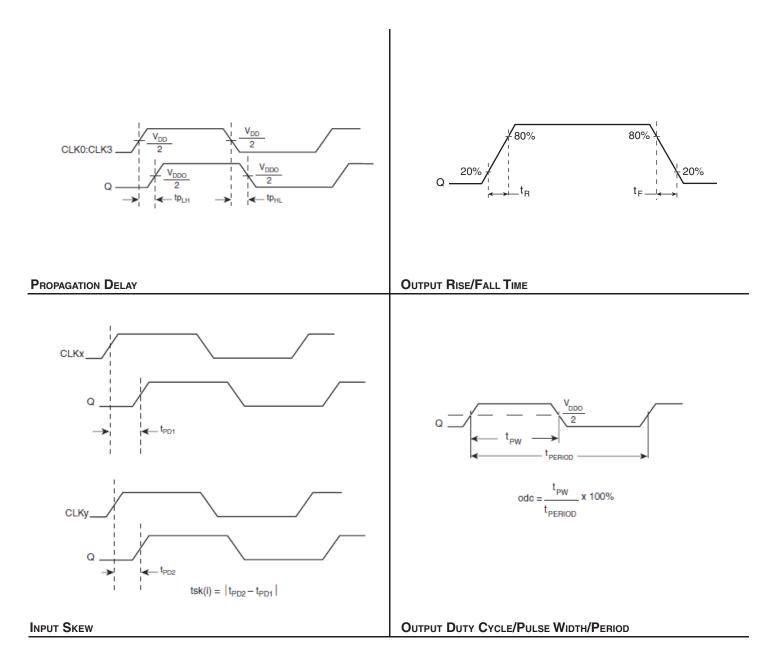




As with most timing specifications, phase noise measurements has issues relating to the limitations of the equipment. Often the noise floor of the equipment is higher than the noise floor of the device. This is illustrated above. The device meets the noise floor of what is shown, but can actually be lower. The phase noise is dependent on the input source and measurement equipment.

# **PARAMETER MEASUREMENT INFORMATION**





# **APPLICATION** INFORMATION

### **RECOMMENDATIONS FOR UNUSED INPUT PINS**

### **INPUTS:**

#### **CLK** INPUTS

For applications not requiring the use of a clock input, it can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from the CLK input to ground.

#### LVCMOS CONTROL PINS

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A  $1k\Omega$  resistor can be used.

# **R**ELIABILITY INFORMATION

# TABLE 6. $\theta_{_{JA}} \text{vs.}$ Air Flow Table for 16 Lead TSSOP

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	137.1°C/W	118.2°C/W	106.8°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	89.0°C/W	81.8°C/W	78.1°C/W

### TRANSISTOR COUNT

The transistor count for 83054 is: 874

# PACKAGE OUTLINE AND PACKAGE DIMENSIONS

PACKAGE OUTLINE - G SUFFIX FOR 16 LEAD TSSOP

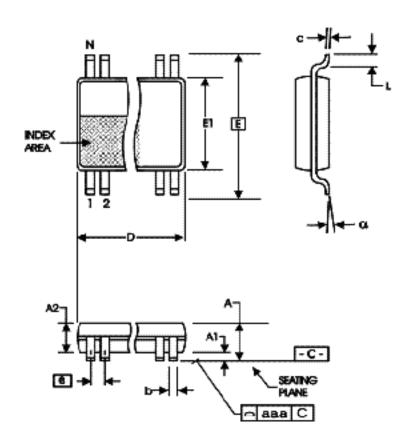


 TABLE 7. PACKAGE DIMENSIONS

SYMBOL	Millin	neters
STWIDOL	Minimum	Maximum
N	1	6
A		1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
с	0.09	0.20
D	4.90	5.10
E	6.40 E	BASIC
E1	4.30	4.50
е	0.65 E	BASIC
L	0.45	0.75
α	0°	8°
aaa		0.10

Reference Document: JEDEC Publication 95, MO-153

### TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
83054AGILF	83054AIL	16 Lead "Lead-Free" TSSOP	tube	-40°C to 85°C
83054AGILFT	83054AIL	16 Lead "Lead-Free" TSSOP	tape & reel	-40°C to 85°C

	REVISION HISTORY SHEET						
Rev	Table	Page	Description of Change	Date			
Α	T8	12	Ordering Information Table - corrected Part/Order Numbers.	1/3/06			
В	T5A - T5E	1 4 - 6 7	Features Section - added Additive Phase Jitter bullet. AC Characteristics Tables - added tjit row and spec. Added Additive Phase Jitter section.	01/04/07			
С	T5A - T5E	4 - 6	AC Characteristics Tables - changed part-to-part skew specs.	03/07/08			
С	Т8	12	Ordering Information - removed leaded devices. Updated data sheet format.	3/20/15			
С	Т8	1 12	General Description - Removed HiPerClockS. Ordering Information - removed LF note below the table. Updated header and footer.	12/15/15			



### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

#### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

#### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Clock Drivers & Distribution category:

Click to view products by Renesas manufacturer:

Other Similar products are found below :

8501BYLF P9090-0NLGI8 854110AKILF 83210AYLF NB6VQ572MMNG HMC6832ALP5LETR RS232-S5 6ES7390-1AF30-0AA0 CDCVF2505IDRQ1 LV5609LP-E NB7L572MNR4G SY100EP33VKG HMC7043LP7FETR ISPPAC-CLK5520V-01T100C EC4P-221-MRXD1 6EP1332-1SH71 6ES7222-1BH32-0XB0 6ES7231-4HD32-0XB0 AD246JN AD246JY AD9510BCPZ AD9510BCPZ-REEL7 AD9511BCPZ AD9511BCPZ-REEL7 AD9512BCPZ AD9512UCPZ-EP AD9513BCPZ AD9514BCPZ AD9514BCPZ-REEL7 AD9515BCPZ AD9515BCPZ-REEL7 AD9572ACPZLVD AD9572ACPZPEC AD9513BCPZ-REEL7 ADCLK950BCPZ AD9553BCPZ HMC940LC4B HMC6832ALP5LE CSPUA877ABVG8 9P936AFLFT 49FCT3805ASOG 49FCT3805DQGI 49FCT3805EQGI 49FCT805CTQG 74FCT3807EQGI 74FCT388915TEPYG 8538013AMILF 853S058AGILF 8SLVD1208-33NBGI 8V79S680NLGI